

MAC212A6FP, MAC212A8FP, MAC212A10FP

Preferred Device

Triacs

Silicon Bidirectional Thyristors

Designed primarily for full-wave ac control applications, such as light dimmers, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied main terminal voltage with positive or negative gate triggering.

- Blocking Voltage to 800 Volts
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in Four Modes
-  Indicates UL Registered — File #E69369
- Device Marking: Logo, Device Type, e.g., MAC212A6FP, Date Code

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage ⁽¹⁾ (T _J = -40 to +125°C, Sine Wave, 50 to 60 Hz, Gate Open)	V _{DRM} , V _{RRM}		Volts
MAC212A6FP		400	
MAC212A8FP		600	
MAC212A10FP		800	
On-State RMS Current (T _C = +85°C) ⁽²⁾ Full Cycle Sine Wave 50 to 60 Hz	I _T (RMS)	12	Amps
Peak Non-repetitive Surge Current (One Full Cycle, Sine Wave, 60 Hz, T _C = +85°C) Preceded and followed by rated current	I _{TSM}	100	Amps
Circuit Fusing Consideration (t = 8.3 ms)	I _{2t}	40	A ² s
Peak Gate Power (T _C = +85°C, Pulse Width = 10 µs)	P _{GM}	20	Watts
Average Gate Power (T _C = +85°C, t = 8.3 ms)	P _G (AV)	0.35	Watt
Peak Gate Current (T _C = +85°C, Pulse Width = 10 µs)	I _{GM}	2.0	Amps
RMS Isolation Voltage (T _A = 25°C, Relative Humidity ≤ 20%) 	V _(ISO)	1500	Volts
Operating Junction Temperature Range	T _J	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

(1) V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

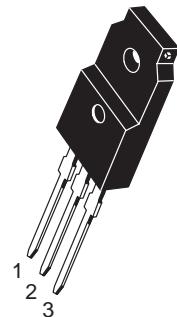
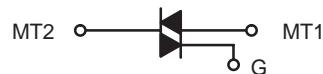
(2) The case temperature reference point for all T_C measurements is a point on the center lead of the package as close as possible to the plastic body.



ON Semiconductor

<http://onsemi.com>

ISOLATED TRIAC (N)
12 AMPERES RMS
400 thru 800 VOLTS



**ISOLATED TO-220 Full Pack
CASE 221C
STYLE 3**

PIN ASSIGNMENT	
1	Main Terminal 1
2	Main Terminal 2
3	Gate

ORDERING INFORMATION

Device	Package	Shipping
MAC212A6FP	ISOLATED TO220FP	500/Box
MAC212A8FP	ISOLATED TO220FP	500/Box
MAC212A10FP	ISOLATED TO220FP	500/Box

Preferred devices are recommended choices for future use and best overall value.

MAC212A6FP, MAC212A8FP, MAC212A10FP

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.1	°C/W
Thermal Resistance, Case to Sink	$R_{\theta CS}$	2.2 (typ)	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	60	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	T_L	260	°C

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Peak Repetitive Blocking Current (V_D = Rated V_{DRM} ; V_{RRM} ; Gate Open) $T_J = 25^\circ\text{C}$ $T_J = +125^\circ\text{C}$	I_{DRM} , I_{RRM}	—	—	10 2.0	μA mA
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ON CHARACTERISTICS

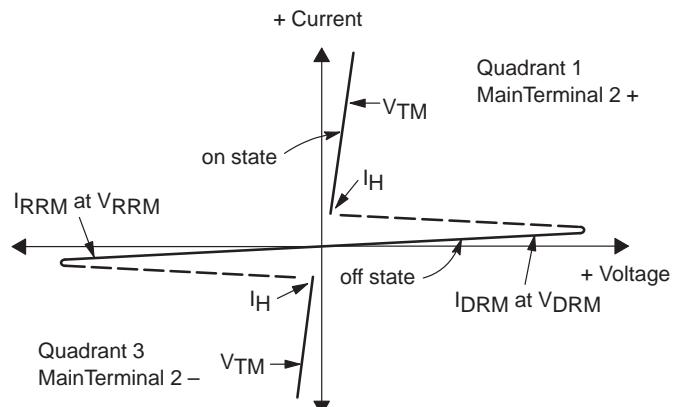
Peak On-State Voltage ($I_{TM} = \pm 17$ A Peak; Pulse Width = 1 to 2 ms, Duty Cycle $\leq 2\%$)	V_{TM}	—	1.3	1.75	Volts
Gate Trigger Current (Continuous dc) (Main Terminal Voltage = 12 Vdc, $R_L = 100$ Ohms) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)	I_{GT}	— — — —	12 12 20 35	50 50 50 75	mA
Gate Trigger Voltage (Continuous dc) (Main Terminal Voltage = 12 Vdc, $R_L = 100$ Ohms) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)	V_{GT}	— — — —	0.9 0.9 1.1 1.4	2.0 2.0 2.0 2.5	Volts
Gate Non-Trigger Voltage (Continuous dc) (Main Terminal Voltage = 12 V, $R_L = 100 \Omega$, $T_J = +125^\circ\text{C}$) All Four Quadrants	V_{GD}	0.2	—	—	Volts
Holding Current (Main Terminal Voltage = 12 Vdc, Gate Open, Initiating Current = ± 200 mA)	I_H	—	6.0	50	mA
Turn-On Time (V_D = Rated V_{DRM} , $I_{TM} = 17$ A, $I_{GT} = 120$ mA, Rise Time = 0.1 μs , Pulse Width = 2 μs)	t_{gt}	—	1.5	—	μs

DYNAMIC CHARACTERISTICS

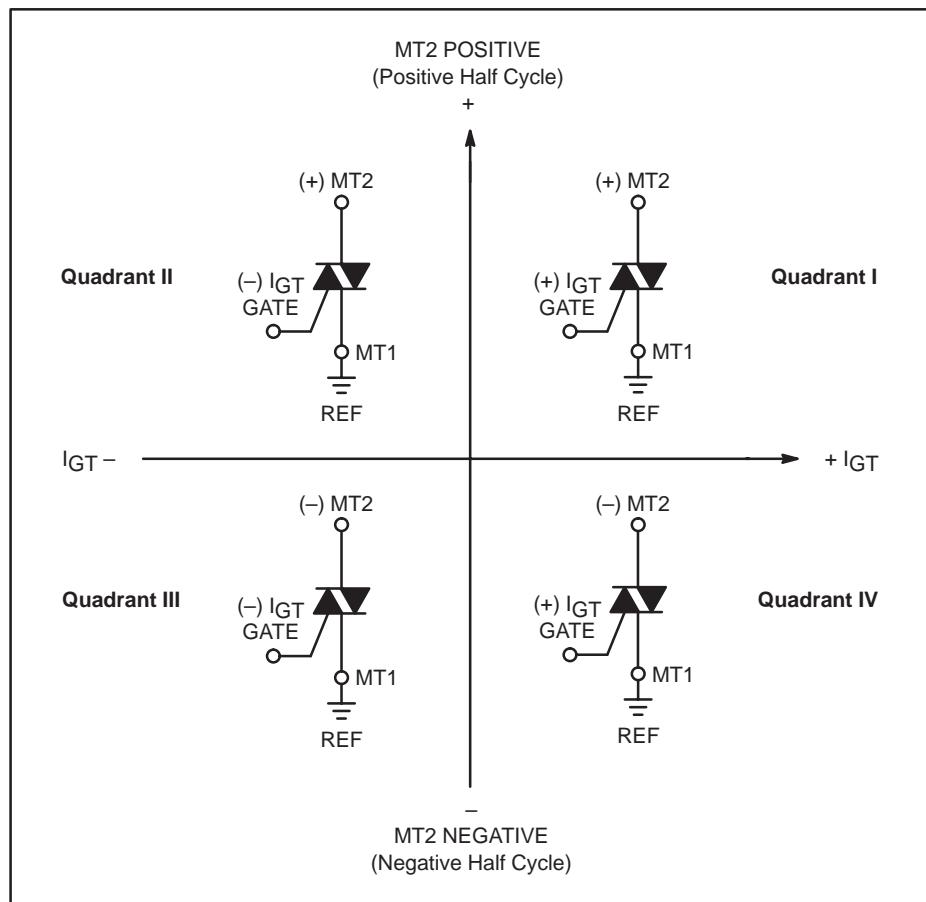
Critical Rate of Rise of Commutation Voltage (V_D = Rated V_{DRM} , $I_{TM} = 17$ A, Commutating $di/dt = 6.1$ A/ms, Gate Unenergized, $T_C = +85^\circ\text{C}$)	$dv/dt(c)$	—	5.0	—	$\text{V}/\mu\text{s}$
Critical Rate of Rise of Off-State Voltage (V_D = Rated V_{DRM} , Exponential Voltage Rise, Gate Open, $T_C = +85^\circ\text{C}$)	dv/dt	—	100	—	$\text{V}/\mu\text{s}$

**Voltage Current Characteristic of Triacs
(Bidirectional Device)**

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I_H	Holding Current

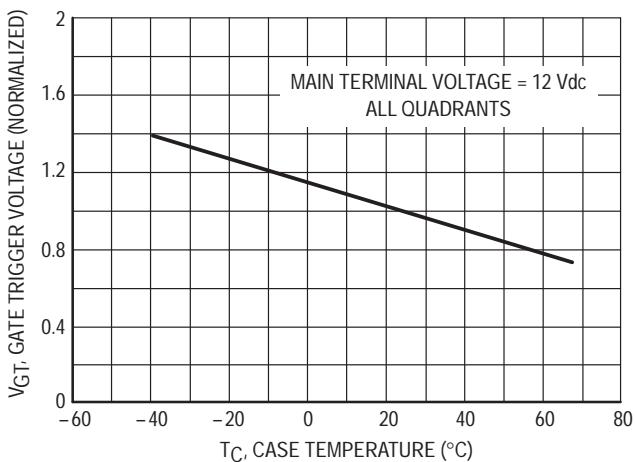
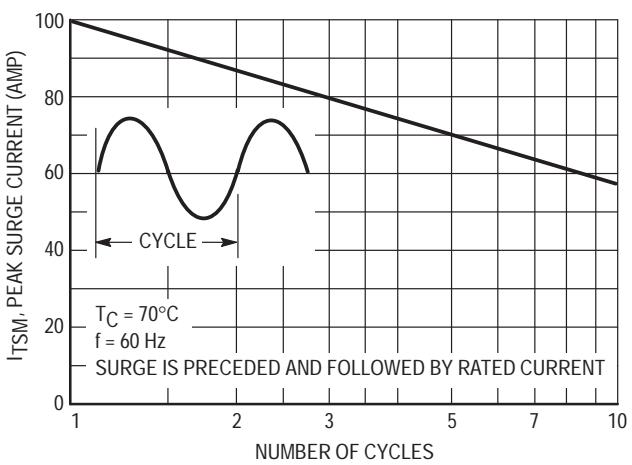
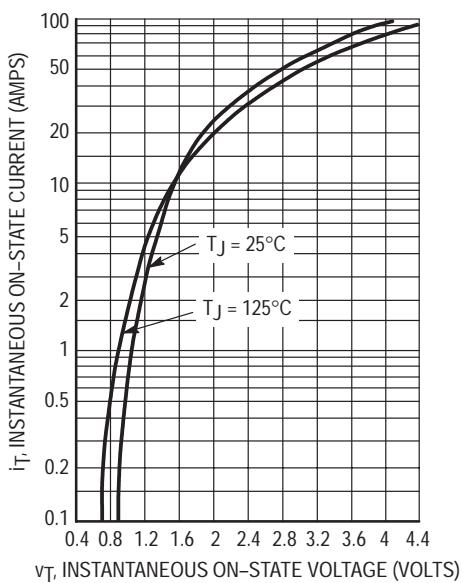
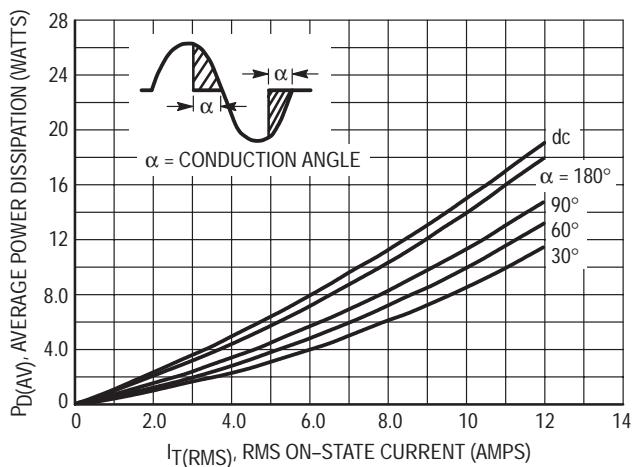
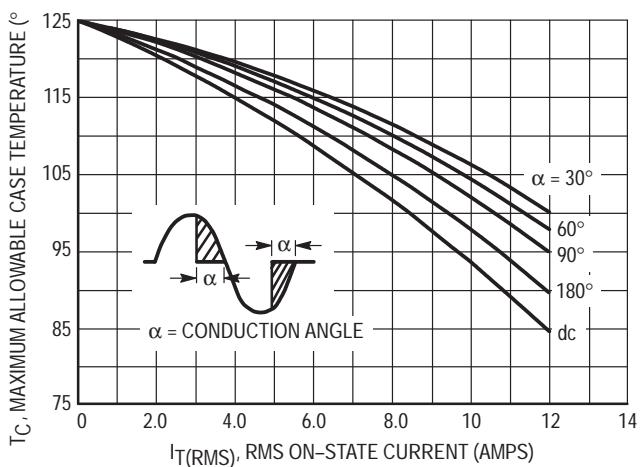


Quadrant Definitions for a Triac



All polarities are referenced to MT1.
With in-phase signals (using standard AC lines) quadrants I and III are used.

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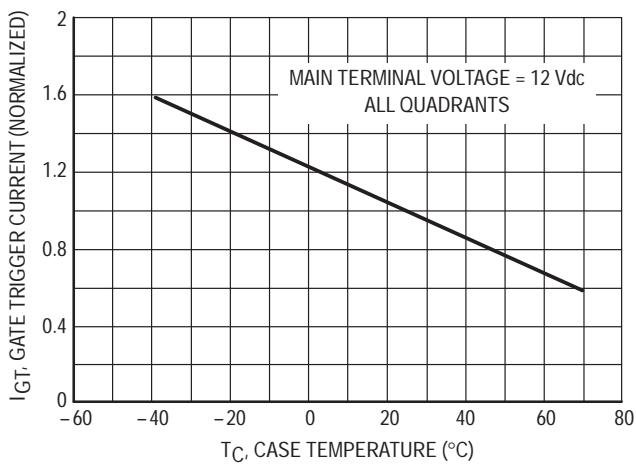


Figure 6. Typical Gate Trigger Current

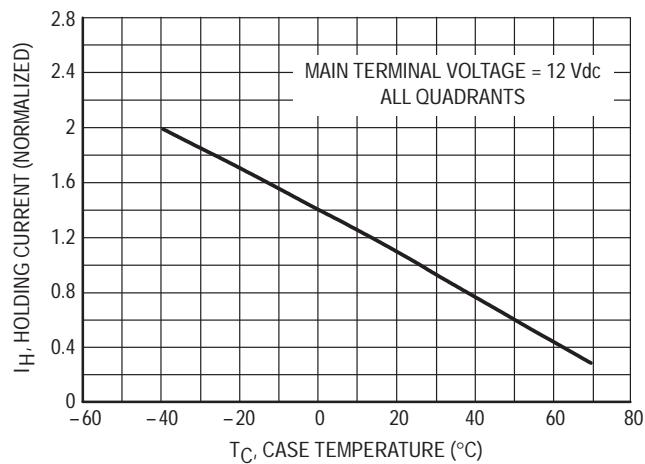


Figure 7. Typical Holding Current

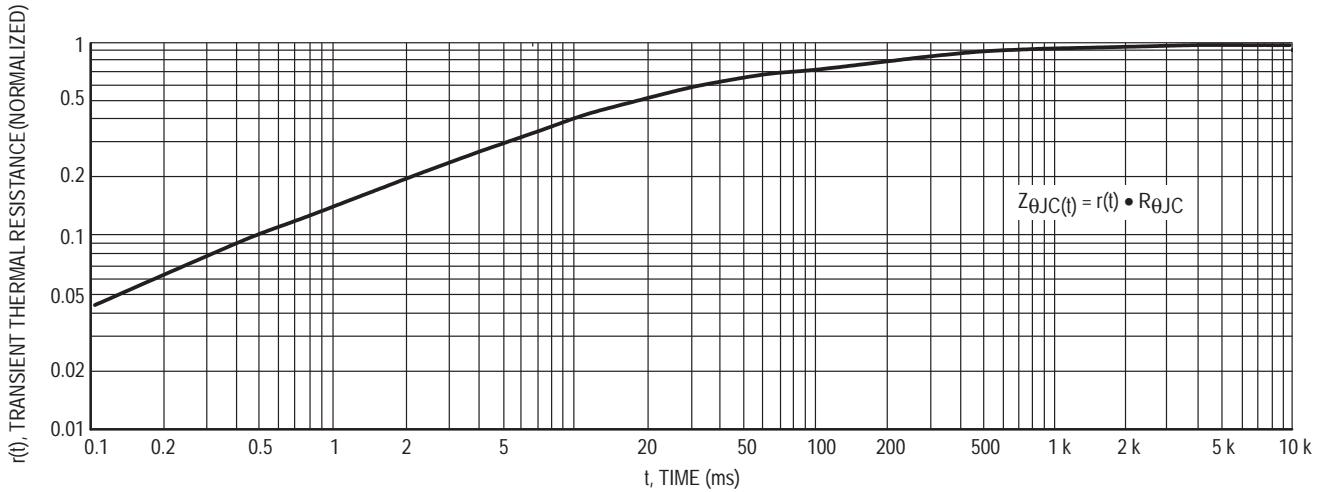
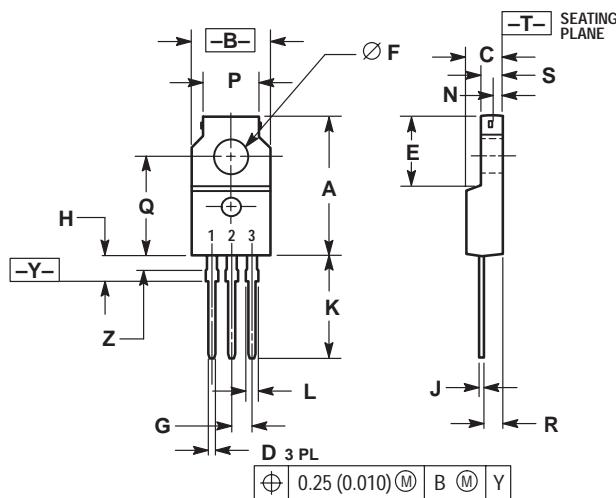


Figure 8. Thermal Response

PACKAGE DIMENSIONS

ISOLATED TO-220 Full Pack
CASE 221C-02
ISSUE C



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. LEAD DIMENSIONS UNCONTROLLED WITHIN DIMENSION Z.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.680	0.700	17.28	17.78
B	0.388	0.408	9.86	10.36
C	0.175	0.195	4.45	4.95
D	0.025	0.040	0.64	1.01
E	0.340	0.355	8.64	9.01
F	0.140	0.150	3.56	3.81
G	0.100 BSC		2.54 BSC	
H	0.110	0.155	2.80	3.93
J	0.018	0.028	0.46	0.71
K	0.500	0.550	12.70	13.97
L	0.045	0.070	1.15	1.77
N	0.049	—	1.25	—
P	0.270	0.290	6.86	7.36
Q	0.480	0.500	12.20	12.70
R	0.090	0.120	2.29	3.04
S	0.105	0.115	2.67	2.92
Z	0.070	0.090	1.78	2.28

STYLE 3:

1. MT 1
2. MT 2
3. GATE

Notes

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